

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2898920

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SEMICONDUCTOR TECHNOLOGY ACADEMIC RESEARCH CENTER	05/30/2014
RECEIVING PARTY DATA	
Name:	FUJITSU SEMICONDUCTOR LIMITED
Street Address:	2-10-23, SHIN-YOKOHAMA
Internal Address:	KOHOKU-KU
City:	YOKOHAMA-SHI, KANAGAWA
State/Country:	JAPAN
Postal Code:	222-0033
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	8069357
CORRESPONDENCE DATA	
Fax Number:	(206)224-0779
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(206)695-1653
Email:	efiling@cojk.com
Correspondent Name:	GEORGE E. RENZONI, PH.D.
Address Line 1:	CHRISTENSEN O'CONNOR JOHNSON KINDNESS
Address Line 2:	1201 THIRD AVENUE, SUITE 3600
Address Line 4:	SEATTLE, WASHINGTON 98101
ATTORNEY DOCKET NUMBER:	SUSU-1-31333
NAME OF SUBMITTER:	GEORGE E. RENZONI
SIGNATURE:	/George E. Renzoni/
DATE SIGNED:	06/16/2014
Total Attachments: 1	
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ASSIGNMENT OF ISSUED LETTERS PATENT
TO SUBSEQUENT PURCHASER

WHEREAS, Semiconductor Technology Academic Research Center, having a principal place of business at 17-2, Shin-Yokohama 3-Chome, Kohoku-ku, Yokohama-shi, Kanagawa 222-0033, Japan (hereinafter the ASSIGNOR), is the owner by assignment of United States Letters Patent No. 8,069,357, entitled MULTI-PROCESSOR CONTROL DEVICE AND METHOD, as recorded on May 19, 2008, in the United States Patent and Trademark Office at Reel 020965, Frame 0546; and,

WHEREAS, Fujitsu Semiconductor Limited, a Japanese corporation having a principal place of business at 2-10-23, Shin-Yokohama, Kohoku-ku, Yokohama-shi, Kanagawa 222-0033, Japan (hereinafter the ASSIGNEE) is desirous of acquiring the entire right, title, and interest therein;

NOW, THEREFORE, for sufficient, good, and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sells, assigns, and transfers unto ASSIGNEE its entire right and title to and interest in said Letters Patent, said Letters Patent to be held and enjoyed by ASSIGNEE as entirely as the same would have been held and enjoyed by ASSIGNOR had this sale, assignment, and transfer not been made;

ASSIGNOR hereby further agrees and promises to execute all instruments and render all such assistance as ASSIGNEE may request in order to enforce said Letters Patent, and to confirm in ASSIGNEE legal title to said Letters Patent, all without charge to ASSIGNEE but at no expense to ASSIGNOR.

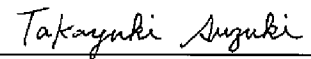
Executed at Kanagawa (city), Japan, this 30th day of May, 2014.


Masao Nakaya
President and CEO

WITNESS:

I certify that I know or have satisfactory evidence that Masao Nakaya is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it as the President and CEO of Semiconductor Technology Academic Research Center to be the free and voluntary act of such party for the uses and purposes mentioned in the instrument."

Dated: May 30, 2014


Print Name: Takayuki Suzuki

GER:md

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